COMPLIANT

GREEN

(5-2008)



# High Stability - Very High Temperature (270 °C) Thin Film Wraparound Chip Resistors



# **FEATURES**

- Operating temperature range:
   55 °C; + 250 °C
- Storage temperature: 55 °C; + 270 °C
- Gold terminations (< 1 µm thick)
- 5 sizes available (0402, 0603, 0805, 1206, 2010); other sizes upon request
- Temperature coefficient down to 5 ppm/°C typical, 10 ppm/°C maximum (- 55 °C; + 270 °C)
- Tolerance down to 0.05 %
- Load life stability: 0.5 % max. after 1000 h at 250 °C (ambient) at Pn
- Shelf life stability: 0.5 % max. after 1000 h at 270 °C and 0.1 % max. after 1000 h at 230 °C
- SMD wraparound
- 0.02 % upon request
- TCR remains constant after long term storage at 270 °C
- Material categorization: For definitions of compliance please see <a href="https://www.vishav.com/doc?99912">www.vishav.com/doc?99912</a>

## INTRODUCTION

For applications such as down hole applications, the need for parts able to withstand very severe conditions (temperature as high as 250 °C powered or up to 270 °C un-powered) has leaded Vishay Sfernice to push out the limit of the thin film technology.

Designers might read the application note: Power Dissipation Considerations in High Precision Vishay Sfernice Thin Film Chip Resistors and Arrays (P, PRA etc...) (High Temperature Application) <a href="https://www.vishay.com/doc?53047">www.vishay.com/doc?53047</a> in conjunction with this datasheet to help them to properly design their PCBs and get the best performances of the PVHT.

Vishay Sfernice R&D engineers will be willing to support any customer design considerations.

STANDARD ELECTRICAL SPECIFICATIONS						
MODEL	SIZE	RESISTANCE RANGE $\Omega$	RATED POWER (1)(2) <i>P</i> <sub>250 °C</sub> W	LIMITING ELEMENT VOLTAGE V	TOLERANCE ± %	TEMPERATURE COEFFICIENT <sup>(3)</sup> ± ppm/°C
PVHT0402	0402	10 to 55K	0.031	50	0.05, 0.1, 0.5, 1	10, 15, 25, 30, 50, 55
PVHT0603	0603	10 to 150K	0.062	75	0.05, 0.1, 0.5, 1	10, 15, 25, 30, 50, 55
PVHT0805	0805	10 to 300K	0.100	150	0.05, 0.1, 0.5, 1	10, 15, 25, 30, 50, 55
PVHT1206	1206	10 to 1.1M	0.165	200	0.05, 0.1, 0.5, 1	10, 15, 25, 30, 50, 55
PVHT2010	2010	10 to 3M	0.2	300	0.05, 0.1, 0.5, 1	10, 15, 25, 30, 50, 55

#### **Notes**

- (1) For power handling improvement, please refer to application note 53047: Power Dissipation Considerations in High Precision Vishay Sfernice Thin Film Chip Resistors and Arrays (High Temperature Applications) <a href="https://www.vishay.com/doc?/53047">www.vishay.com/doc?/53047</a> and consult Vishay Sfernice
- (2) See Table 2 on next page
- (3) See Table 1 on next page

CLIMATIC SPECIFICATIONS			
Operating temperature range	- 55 °C; + 250 °C		
Storage temperature range	- 55 °C; + 270 °C		

# Caution:

Performances obtained with following mounting conditions:

PCB: Alumina

Solder paste: PbSnAg (93.5/5/1.5)

MECHANICAL SPECIFICATIONS			
Substrate	Alumina		
Resistive Element	Thin Film		
Passivation	Silicon nitride (Si <sub>3</sub> N <sub>4</sub> )		
Protection	Epoxy + Silicone		
Terminations	Gold (< 1 µm) over nickel barrier		

#### Note

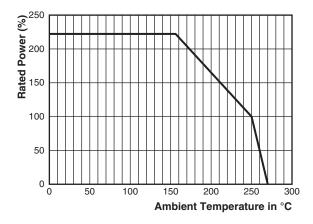
For other terminations, please consult

# Vishay Sfernice

TABLE 1 - TEMPERATURE COEFFICIENT				
С	5 ppm/°C	- 55 °C; + 155 °C		
	10 ppm/°C	- 55 °C; + 270 °C		
Y	10 ppm/°C	- 55 °C; + 155 °C		
	15 ppm/°C	- 55 °C; + 270 °C		
E	25 ppm/°C	- 55 °C; + 155 °C		
	30 ppm/°C	- 55 °C; + 270 °C		
Н	50 ppm/°C	- 55 °C; + 155 °C		
	55 ppm/°C	- 55 °C; + 270 °C		

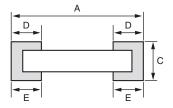
TABLE 2					
SERIES	RANGE (Ω)	TOL. (± %)	TCR CODE		
0402	From <b>10R</b> to 55K	0.05, 0.1, 0.5, 1	C; Y; E; H		
0603	From <b>10R</b> to 150K	0.05, 0.1, 0.5, 1	C; Y; E; H		
0805	From <b>10R</b> to 300K	0.05, 0.1, 0.5, 1	C; Y; E; H		
1206	From <b>10R</b> to 1.1M	0.05, 0.1, 0.5, 1	C; Y; E; H		
2010	From <b>10R</b> to 3M	0.05, 0.1, 0.5, 1	C; Y; E; H		

# **POWER DERATING CURVE**





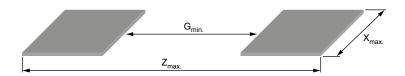
# **DIMENSIONS** in millimeters (inches)





	Α	В		D/E	
CASE SIZE	MAX. TOL. + 0.152 (+ 0.006) MIN. TOL. - 0.152 (- 0.006)	MAX. TOL. + 0.127 (+ 0.005) MIN. TOL. - 0.127 (- 0.005)	С		
	NOMINAL	NOMINAL		NOMINAL	NOMINAL
0402	1.00 (0.039)	0.60 (0.024)		0.25 (0.010)	0.1 (0.004)
0603	1.52 (0.060)	0.85 (0.033)		0.38 (0.015)	
0805	1.91 (0.075)	1.27 (0.050)	0.5 (0.02) ± 0.127 (0.005)	0.38 (0.013)	0.12 (0.005)
1206	3.06 (0.120)	1.60 (0.063)	, ,	0.40 (0.016)	0.13 (0.005)
2010	5.08 (0.200)	2.54 (0.100)		0.48 (0.019)	

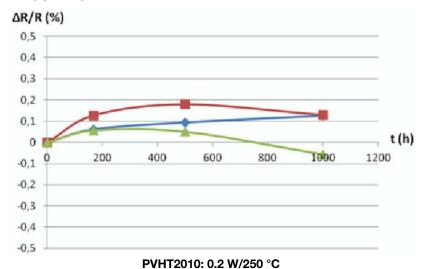
# SUGGESTED LAND PATTERN (TO IPC-7351A)



CHIP SIZE	DIMENSIONS (in millimeter)				
CHIP SIZE	Z <sub>max</sub> .	G <sub>min.</sub>	X <sub>max.</sub>		
0402	1.55	0.15	0.73		
0603	2.37	0.35	0.98		
0805	2.76	0.74	1.40		
1206	3.91	1.85	1.73		
2010	5.93	3.71	2.67		



## LOAD LIFE STABILITY CURVES



Note

Test performed on samples of 3 different values coming from different lots.

#### **PACKAGING**

ESD packaging available: waffle-pack, and plastic tape and reel (low conductivity). Paper tape available upon request (ESD only).

		NUMBER OF PIE	TAPE WIDTH		
SIZE MOQ		WAFFLE PACK		TAPE AND REEL	
		2" × 2"	MIN.	MAX.	
0402				5000	
0603		100		5000	0
0805	100		100	4000	8 mm
1206		140		4000	
2010		60		2000	8 mm

## **PACKAGING RULES**

#### **Waffle Pack**

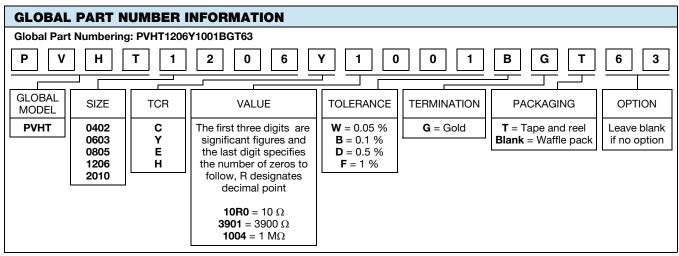
Can be filled up to maximum quantity indicated in the table here above, taking into account the minimum order quantity. When quantity ordered exceeds maximum quantity of a single waffle pack, the waffle packs are stacked up on the top of each other and closed by one single cover.

To get "not stacked up" waffle pack in case of ordered quantity > maximum number of pieces per package: Please consult Vishay Sfernice for specific ordering code.

### **Tape and Reel**

Can be filled up to maximum quantity indicated in the table here above, taking into account the minimum order quantity. When quantity ordered is between the MOQ and the maximum reel capacity, only one reel is provided.

When several reels are needed for ordered quantity within MOQ and maximum reel capacity: Please consult Vishay Sfernice for specific ordering code.





# **Legal Disclaimer Notice**

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# **Material Category Policy**

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

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